



Product Change Notification

112135 - 00

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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Product Change Notification

Change Notification#:	112135 - 00
Change Title:	Intel® PRO/1000 MT Server Adapter(Everson Endicott) OEM Gen SKU PWLA8490MTG1P20 MM#844795 Retail SKUs PWLA8490MT MM# 845956 & PWLA8490MTBLK5 MM#847742 Intel® PRO/1000 MF Dual Port Server Adapter(Double Eldridge) Retail SKUs PWLA8492MF MM#844141 & PWLA8492MFBLK5 MM#847744 PCN 112135-00 Label, Documentation ROHS Flyer, Remove CDA, Update Labels
Date of Publication:	March 19, 2013

Key Characteristics of the Change:

Label
Documentation

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	April 03, 2013
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Description of Change to the Customer:

The Intel® PRO/1000 MT Server Adapter & Intel® PRO/1000 MF Dual Port Server Adapter SKUs listed in the product table below will undergo the following changes:

1. ROHS Flyer

Add or update the China "EU" ROHS flyer to over pack box. Includes the Intel contact info, per Intel to meet an EU ROHS recast, now officially called ROHS 2, that will go into effect as of 1/1/2013. In this recast, there is a requirement to include the single point of contact address label for items requiring the "CE" mark.



As part of Intel's efforts to be environmentally responsible, a CD is no longer included in the box with this adapter. Download the latest drivers, software, and documentation at: <http://www.intel.com/support/go/network/adapter/cd.htm>

关于符合中国《电子信息产品污染控制管理办法》的声明
Management Methods on Control of Pollution from Electronic Information Products
(China RoHS declaration)

产品中有毒有害物质的名称及含量

部件名称	有毒有害物质或元素					
	铅 (Pb)	汞 (Hg)	镉 (Cd)	六价铬 (Cr (VI))	多溴联苯 (PBB)	多溴二苯醚 (PBDE)
印刷板组件	×	○	○	○	○	○

○：表示该有毒有害物质在该部件所有均质材料中的含量均在 SJ/T 11363-2006 标准规定的限量要求以下。
×：表示该有毒有害物质至少在该部件的某一均质材料中的含量超出 SJ/T 11363-2006 标准规定的限量要求。

For regulatory information go to the user guide:

<http://www.intel.com/support/go/network/adapter/userguide.htm>

For CE Mark-Related Questions:
Intel Corporation
Attn: Corporate Quality
2200 Mission College Blvd
Santa Clara, CA 95054-1549
USA

2. CDA Removal (SKUs: PWLA8490MT, PWLA8490MTBLK5, PWLA8492MF & PWLA8492MFBLK5)

As part of Intel's efforts in environmental responsibility, Intel will no longer include a software CD in the box with the Retail version of Intel® PRO/1000 MT Server Adapters and Intel® PRO/1000 MF Dual Port Server Adapters.

Because of the rapid pace of technology, the software on the CD is usually out of date before the adapter is sold. Drivers that enable basic functionality are included with most operating systems and the latest software, drivers, and documentation are available for download. See ROHS flyer described above.

3. Distribution Label Change

Intel Corp is standardizing packaging label formats across the corporation. This will facilitate easier receiving for the end customer.

Intel will begin implementation of UPC and EAN (European Article Number) codes on the product outer case labels.

The online product catalog (ARK) will be updated with the new UPC & EAN info.

A new line of text will be added that states either:

- Product is individually labeled for resale.
- Product is not individually labeled for resale.

Additional fields are being added to display the outer case UPC and EAN codes for overall carton quantity. New UPC codes for individual boxes are also being added.

2D matrix label will be added for easier product information scanning.

Customers should be aware that UPC and EAN codes on the outer case carton labels will be changed and that they may need to update their incoming receiving operations. Customers may receive both current and new inventory as the implementation occurs.

Product Code	MM#	UPC	EAN	OBL UPC	OBL EAN
PWLA8492MF	844141	735858156479	5032037046480		
PWLA8490MTG1P20	844795	735858256544	5032037048842	735858156486	5032037046473
PWLA8490MT	845956	735858156516	5032037041713		
PWLA8490MTBLK5	847742	735858256551	5032037048859	735858155779	5032037041669
PWLA8492MFBLK5	847744	735858156509	5032037041676		

Example of old & new disti (for over-pack boxes) & outer box (for retail single boxes) labels below:

Existing Label (Example only)	New Label (Example only)
<p>MM: 904198 DTY: 10 BATCH: MYAD29F5CH PCODE: E1G44HT CARTON: AD22739006 INTEL(R) ETHERNET SERVER ADAPTER I340-T4 E1G44HT, SINGLE PACK Intel(R) I340, 1G, DUAL PORT, COPPER RETAIL VERSION: E76827-005 DATE: 09/15/2012 MAKE IN MALAYSIA DATE: 09/2012 CPU-E6926B (B) CE, RoHS, 2nd M intct HF-@D/@D N232 Intel Microelectronics Asia 8 Flr, 205, Tun-Hua North Rd Taipei D33025 Türkiye Cumhuriyeti: EEE Yönetmeliğine Uygundur</p>	<p>Product inside is not labeled for individual resale</p> <p>Product Code: PXXXXXXXXXXXXXXXXX</p> <p>U P C: 7 35858 12345 7 E A N: 0 123456 789128</p> <p>Version: VVVVVV-VVV Date: 10/05/2012</p> <p>MM#: MMMMMM Enclosed S/N's: </p> <p>Batch#: BBBBBBBBBB Carton: CCCCCCCCCC</p> <p>Qty: QQQ See supplemental label for individual serial numbers</p> <p>Made in Malaysia</p> <p>Product Description Line 1 Product Description Line 2 Product Description Line 3 Product Description Line 4</p> <p>DATE: MM/YYYY KCC-REM-CPU-KKKKKK</p> <p>Intel Microelectronics Asia 8 Flr, 205, Tun-Hua North Rd Taipei D33025 CE, N232</p>
<p>FOLD HERE</p> <p>MM: 914211 INTEL(R) ETHERNET SERVER ADAPTER I350-F2 I350F2, SINGLE PACK I350 R1, 1G, DUAL PORT, ADAPTER RETAIL MADE IN MALAYSIA VERSION: 626026-001 DATE: 10/20/2011 CE, RoHS, 2nd M intct HF-@D/@D N232 Intel Microelectronics Asia 8 Flr, 205, Tun-Hua North Rd Taipei D33025 DATE: 10/2011 KCC-REM-CPU-621286 Türkiye Cumhuriyeti: EEE Yönetmeliğine Uygundur</p> <p>MM: 914211 INTEL(R) ETHERNET SERVER ADAPTER I350-F2 I350F2, SINGLE PACK I350 R1, 1G, DUAL PORT, ADAPTER RETAIL SN: 01B5A0431A0615814001</p>	<p>Product Description Line 1 Product Description Line 2 Product Description Line 3 Product Description Line 4</p> <p>Version: VVVVVV-VVV Date: 10/05/2012</p> <p>Product Code: PXXXXXXXXXXXXXXXXX</p> <p>U P C: 7 35858 12345 7 E A N: 0 123456 789128</p> <p>MM#: MMMMMM</p> <p>S/N: SSSSSSSSSSSSSSSSSSS Batch#: BBBBBBBBBB</p> <p>Made in Malaysia</p> <p>DATE: MM/YYYY KCC-REM-CPU-KKKKKK</p> <p>Intel Microelectronics Asia 8 Flr, 205, Tun-Hua North Rd Taipei D33025 CE, N232</p>

4. Product Label Change

Intel is removing the UPC code on the PBA Product ID label, and using the extra space to incorporate the WEEE and/or eFUP logos onto the Product ID label. The Product ID label is currently placed on either the front or back of the Printed board (PB).

Due to the standardization of UPC codes on the shipping label, the UPC code on the board Product ID label is no longer required, and it will be removed. If applicable, the WEEE and/or EFUP markings (WEEE= Waste Electrical and Electronic Equipment (Directive) and EFUP = Environment Friendly Use Period (China RoHS directive) (currently on separate, individual labels attached to the printed board) will be incorporated on the Product ID label.

Current label example:



New label example:



5. As a result of this change the TA (Top Assembly) and PBA (Printed Board Assembly) numbers will roll as listed in the affected product table below.

Customer Impact of Change and Recommended Action:

Generic Customer Impact:

Customers can expect to receive mixed inventory until current inventory levels have been depleted.

Please contact your local Intel Field Sales Representative if you have any further questions about this change.

Products Affected / Intel Ordering Codes:

Product Name	Product Code	MM#	Pre Change TA	Post Change TA	Pre Change PBA	Post Change PBA
Intel® PRO/1000 MF Dual Port Server Adapter (Double Eldridge) Retail	PWLA8492MF	844141	A85401-012	A85401-013	C41300-009	C41300-010
Intel® PRO/1000 MT Server Adapter (Everson Endicott) OEM Gen	PWLA8490MTG1P20	844795	A85393-008	A85393-009	C48637-007	C48637-008
Intel® PRO/1000 MT Server Adapter(Everson Endicott) Retail	PWLA8490MT	845956	A85402-012	A85402-013	C36840-010	C36840-011
Intel® PRO/1000 MT Server Adapter(Everson Endicott) Retail	PWLA8490MTBLK5	847742	A90837-011	A90837-012	C36840-010	C36840-011
Intel® PRO/1000 MF Dual Port Server Adapter (Double Eldridge) Retail	PWLA8492MFBLK5	847744	A85398-012	A85398-013	C41300-009	C41300-010

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
March 19, 2013	00	Originally Published PCN